CC430F5137 Device Erratasheet

1 Revision History

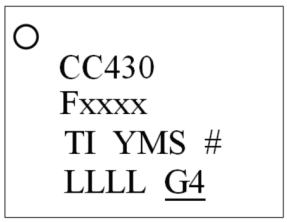
✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev E
ADC24	✓
ADC25	✓
ADC27--CC430	✓
ADC29	✓
COMP4	✓
CPU18	✓
CPU20	✓
CPU24	✓
CPU25	✓
CPU26	✓
CPU27	✓
CPU28	✓
CPU29	✓
CPU30	✓
CPU31	✓
CPU32	✓
CPU33	✓
CPU34	✓
CPU35	✓
CPU39	✓
CPU40	✓
DMA4	✓
DMA7	✓
DMA8	✓
EEM8	✓
EEM9	✓
EEM11	✓
EEM13	✓
EEM14	✓
EEM16	✓
EEM17	✓
FLASH29	✓
FLASH31	✓
FLASH37	✓
JTAG20	✓
MPY1	✓

Errata Number	Rev E
PMAP1	✓
PMM8	✓
PMM9	✓
PMM10	✓
PMM11	✓
PMM12	✓
PMM14	✓
PMM15	✓
PMM17	✓
PORT15	✓
PORT16	✓
RF1A1	✓
RF1A2	✓
RF1A3	✓
RF1A5	✓
RF1A6	✓
RF1A8	✓
SYS16	✓
TAB23	✓
UCS6	✓
UCS7	✓
UCS9	✓
UCS10	✓
UCS11	✓
USCI26	✓
USCI30	✓
USCI31	✓
WDG4	✓

2 Package Markings

RGZ48 *QFN (RGZ), 48 Pin*



TI = TI
YM = Year and Month Date Code
LLLL = LOT Trace Code
S = Assembly Site Code
# = DIE Revision
o = PIN 1

3 Detailed Bug Description

ADC24 *ADC12_A Module*

Function Unexpected ADC12 current draw when ADC12ENC = 1

Description When set, the ADC12ENC bit issues a clock request to the selected source clock, even before the conversion trigger. This causes some extra current consumption, depending on the selected clock.

Workaround None.

ADC25 *ADC12_A Module*

Function Write to ADC12CTL0 triggers ADC12 when CONSEQ = 00

Description If ADC conversions are triggered by the Timer_B module and the ADC12 is in single-channel single-conversion mode (CONSEQ = 00), ADC sampling is enabled by write access to any bit(s) in the ADC12CTL0 register. This is contrary to the expected behavior that only the ADC12 enable conversion bit (ADC12ENC) triggers a new ADC12 sample.

Workaround When operating the ADC12 in CONSEQ=00 and a Timer_B output is selected as the sample and hold source, temporarily clear the ADC12ENC bit before writing to other bits in the ADC12CTL0 register. The following capture trigger can then be re-enabled by setting ADC12ENC = 1.

ADC27--CC430 *ADC12_A Module*

Function Integral and differential non-linearity exceed specifications

Description The ADC12_A integral and differential non-linearity may exceed the limits specified in the data sheet under the following conditions:

- If the internal voltage reference generator is used

and

- If the reference voltage is not buffered off-chip

and

- If fADC12CLK > 2.7 MHz

or

If the internal voltage reference is selected for 1.5-V output mode.

The non-linearity can be up to tens of LSBs. This is due to the internal reference buffer providing insufficient drive for the switched capacitor array of the ADC12_A.

Workaround - Turn on the output of the internal voltage reference to increase the drive strength of the reference to the ADC_12 core:

- If REFMSTR bit in REFCTL0 is 0 (allowing Shared REF to be controlled by ADC_A reference control bits)

Set ADC12REFON bit in ADC12CTL0 = 1

and

Set ADC12REFOUT bit in ADC12CTL2 = 1

- If REFMSTR bit in REFCTL0 is 1

Set REFON and REFOUT bits in REFCTL0 = 1

or

- Ensure fADC12CLK < 2.7 MHz and select the internal voltage reference in 2.5-V output mode.

Depending on the frequency of the source of fADC12CLK (ACLK, MCLK, SMCLK, or MODOSC), select the divider bits accordingly.

- If fADC12CLK = MODOSC (ADC12OSC)

ADC12CTL1 |= ADC12DIV_2; // Divide clock by 2

- If fADC12CLK = ACLK/SMCLK/MCLK > 2.7 MHz

Use ADC12DIVx and/or ADC12PDIVx bits to reduce the selected clock frequency to between 0.45 MHz and 2.7 MHz. And set both REFVSELx bits in REFCTL0 to REFVSEL_3 (select 2.5-V output).

ADC29 *ADC12_A Module*

Function Incorrect temperature sensor calibration data

Description In some devices, the internal temperature sensor calibration data for 30 degC are invalid for all VRef conditions. Devices with correct calibration data show a difference of at least 30 LSBs between the different VRef conditions. When using incorrect calibration data with the internal temperature sensor ADC samples, the calculated results can be unreliable. Calibration data for 85 degC are not affected.

Workaround Recalibrate the temperature sensor for 30 degC at the application level.

COMP4 *COMP_B Module*

Function CBEX and CBOUTPOL bits do not invert comparator I/O

Description Setting the exchange bit, CBEX, does not interchange the comparator inputs. Similarly setting the output polarity bit, CBOUTPOL, does not invert the output of the comparator.

Workaround To obtain an inverted output from the comparator, invert the input signals to the comparator using the channel input selector bits, CBIPSEL_x and CBIMSEL_x. Make sure to use a MOV instruction so that the inputs are inverted simultaneously.

CPU18 *CPUXv2 Module*

Function LPM instruction can corrupt PC/SR registers

Description The PC and SR registers have the potential to be corrupted when:

- An instruction using register, absolute, indexed, indirect, indirect auto-increment, or symbolic mode is used to set the LPM bits AND (e.g. BIS &xyh, SR)

- This instruction is followed by a CALL or CALLA instruction

Upon servicing an interrupt service routine, the program counter (PC) is pushed twice onto the stack instead of the correct operation where the PC, then the SR registers are pushed onto the stack. This corrupts the SR and possibly the PC on RETI from the ISR.

Workaround Insert a NOP or __no_operation() intrinsic function between the instruction to enter low power mode and the CALL or CALLA instruction

CPU20 *CPUXv2 Module*

Function An unexpected Vacant Memory Access Flag (VMAIFG) can be triggered due to the CPU autoincrement of the MAB+2 outside the range of a valid memory block.

Description The VMAIFG can be triggered under the following conditions:

1. If an interrupt is requested, fetched by the CPU, but lost before excution of the interrupt service routine.

OR

2. If a PC-modifying instruction (e.g. - ret, push, call, pop, jmp, br) is fetched from the last address of a section of memory (e.g.- FLASH, RAM) that is not continguous to a higher, valid section on the memory map.

Workaround For case 1 - None.

For case 2 - If code is affected, edit the linker command file to make the last four bytes of affected memory sections unavailable.

CPU24 *CPUXv2 Module*

Function Program counter corruption following entry into low power mode

Description The program counter is corrupted when an interrupt event occurs in the time between (and including) one cycle before and one cycle after the CPUOFF bit is set in the status register. This failure occurs when the BIS instruction is followed by a CALL or CALLA instruction using the following addressing modes:

BIS &, SR

CALLA indir, indir autoinc, reg

BIS INDEX, SR

CALLA indir, indir autoinc, reg

BIS reg, SR

CALLA reg, indir, indir autoinc

NOTE: Due to the instruction emulation, the EINT instruction, as well as the __enable_interrupts() and possibly the __bis_SR_register() intrinsic functions are affected.

Workaround Insert a NOP instruction or __no_operation() intrinsic function call between the BIS and CALL or CALLA instructions.

CPU25 *CPUXv2 Module*

Function DMA transfer does not execute during low power mode

Description If the following instruction sequence is used ([] denotes an addressing mode) to enter a low-power mode, and the DMARMWDIS bit is set, then DMA transfers are blocked for the duration of the low-power mode.

BIS [register|index|absolute|symbolic],SR

CALLA [register]

Workaround

1. Insert a NOP instruction or __no_operation() intrinsic function call between the BIS and CALLA instructions

OR

2. Temporarily clear the DMARMWDIS bit when entering low power mode

CPU26 *CPUXv2 Module*

Function

CALL SP does not behave as expected

Description

When the intention is to execute code from the stack, a CALL SP instruction skips the first piece of data (instruction) on the stack. The second piece of data at SP+2 is used as the first executable instruction.

Workaround

Write the op code for a NOP as the first instruction on the stack. Begin the intended subroutine at address SP + 2.

CPU27 *CPUXv2 Module*

Function

Program Counter (PC) is corrupted during the context save of a nested interrupt

Description

When a low power mode is entered within an interrupt service routine that has enabled nested interrupts (by setting the GIE bit), and the instruction that sets the low power mode is directly followed by a RETI instruction, an incorrect value of PC + 2 is pushed to the stack during the context save. Hence, the RETI instruction is not executed on return from the nested interrupt and the PC becomes corrupted.

Workaround

Insert a NOP or __no_operation() intrinsic function between the instruction that sets the lower power mode and the RETI instruction.

CPU28 *CPUXv2 Module*

Function

PC is corrupted when using certain extended addressing mode combinations

Description

An extended memory instruction that modifies the program counter executes incorrectly when preceded by an extended memory write-back instruction under the following conditions:

First instruction:

2-operand instruction, extended mode using (register,index), (register,absolute), OR (register,symbolic) addressing modes

Second instruction:

2-operand instruction, extended mode using the (indirect,PC), (indirect auto-increment,PC), OR (indexed [with ind 0], PC) addressing modes

Example:

BISX.A R6,&AABCD

ANDX.A @R4+,PC

Workaround

1. Insert a NOP or a __no_operation() intrinsic function between the two instructions

Or

2. Do not use an extended memory instruction to modify the PC

CPU29 *CPUXv2 Module*

Function Using a certain instruction sequence to enter low power mode(s) affects the instruction width of the first instruction in an NMI ISR

Description If there is a pending NMI request when the CPU enters a low power mode (LPMx) using an instruction of Indexed source addressing mode, and that instruction is followed by a 20-bit wide instruction of Register source and destination addressing modes, the first instruction of the ISR is executed as a 20-bit wide instruction.

Example:

main:

...

MOV.W [indexed],SR ; Enter LPMx

MOVX.A [register],[register] ; 20-bit wide instruction

...

ISR_start:

MOV.B [indexed],[register] ; ERROR - Executed as a 20-bit instruction!

Note: [] indicates addressing mode

Workaround 1. Insert a NOP or a __no_operation() intrinsic function following the instruction that enters the LPMx using indexed addressing mode

OR

2. Use a NOP or a __no_operation() intrinsic function as first instruction in the ISR

OR

3. Do not use the indexed mode to enter LPMx

CPU30 *CPUXv2 Module*

Function ADDA, SUBA, CMPA [immediate],PC behave as if immediate value were offset by -2

Description The extended address instructions ADDA, SUBA, CMPA in immediate addressing mode are represented by 4-bytes of opcode (see the MSP430F5xx Family User's Guide MSP430F5xx Family User's Guide for more details). In cases where the program counter (PC) is used as the destination register only 2 bytes of the current instruction's 4-byte opcode are accounted for in the PC value. The resulting operation executes as if the immediate value were offset by a value of -2.

Ideal: ADDA #Immediate-4, PC

...is equivalent to...

Actual: ADDA #Immediate-2, PC

** NOTE: The MOV instruction is not affected **

Workaround 1) Modify immediate value in software to account for the offset of 2.

OR

2) Use extended 20-bit instructions (addx.a, subx.a, cmpx.a).

CPU31 *CPUXv2 Module*

Function SP corruption

Description When the instruction PUSHX.A is executed using the indirect auto-increment mode with the stack pointer (SP) as the source register [PUSHX.A @SP+] the SP is consequently corrupted. Instead of decrementing the value of the SP by four, the value of the SP is replaced with the data pointed to by the SP previous to the PUSHX.A instruction execution.

Workaround None. The compiler will not generate a PUSHX.A instruction that involves the SP.

CPU32 *CPUXv2 Module*

Function CALLA PC executes incorrectly

Description When the instruction CALLA PC is executed, the program counter (PC) that is pushed onto the stack during the context save is incorrectly offset by a value of -2.

Workaround None. The compiler will not generate a CALLA PC instruction.

CPU33 *CPUXv2 Module*

Function CALLA [indexed] may corrupt the program counter

Description When the Stack Pointer (SP) is used as the destination register in the CALLA index(Rdst) instruction and is preceded by a PUSH or PUSHX instruction in any of the following addressing modes: Absolute, Symbolic, Indexed, Indirect register or Indirect auto increment, the "index" of the CALLA instruction is not sign extended to 20-bits and is always treated as a positive value. This causes the Program Counter to be set to a wrong address location when the index of the CALLA instruction represents a negative offset.

NOTE:

1. This erratum only applies when the instruction sequence is: PUSH or PUSHX followed by CALLA index(SP)

2. This erratum does not apply if the PUSH or PUSHX instruction is used in the Register or Immediate addressing mode

3. This erratum only applies when SP is used as the destination register in the CALLA index(Rdst) instruction

Workaround Place a "NOP" instruction in between the PUSH or PUSHX and the CALLA index(SP) instructions.

NOTE: This bug has no compiler impact as the compiler will not generate a CALLA instruction that uses indexed addressing mode with the SP.

CPU34 *CPUXv2 Module*

Function CPU may be halted if a conditional jump is followed by a rotate PC instruction

Description If a conditional jump instruction (JZ, JNZ, JC, JNC, JN, JGE, JL) is followed by an Address Rotate instruction on the PC (RRCM, RRAM, RLAM, RRUM) and the jump is not performed, the CPU is halted.

Workaround Insert a NOP between the conditional jump and the rotate PC instructions.

CPU35 *CPUXv2 Module*

Function Instruction BIT.B @Rx,PC uses the wrong PC value

Description The BIT(.B/.W) instruction in indirect register addressing mode uses the wrong PC value. This instruction is represented by 2 bytes of opcode. If the Program Counter (PC) is used as the destination register, the 2 opcode bytes of the current BIT instruction are not accounted for. The resulting operation executes the instruction using the wrong PC value and this affects the results in the Status Register (SR).

Workaround None.

Note: The compiler will not generate a BIT instruction that uses the PC as an operand.

CPU39 *CPUXv2 Module*

Function PC is corrupted when single-stepping through an instruction that clears the GIE bit

Description Single-stepping over an instruction that clears the General Interrupt Enable bit (for example DINT or BIC #GIE,SR) when the GIE bit was previously set may corrupt the PC. For example, the DINT or BIC #GIE,SR is a 2-byte instruction. Single stepping through this instruction increments the PC by a value of 4 instead of 2 thus corrupting the next PC value.

Note: This erratum applies to debug mode only.

Workaround Insert a NOP or __no_operation() intrinsic immediately after the line of code that clears the GIE bit.

CPU40 *CPUXv2 Module*

Function PC is corrupted when executing jump/conditional jump instruction that is followed by instruction with PC as destination register or a data section

Description If the value at the memory location immediately following a jump/conditional jump instruction is 0X40h or 0X50h (where X = don't care), which could either be an instruction opcode (for instructions like RRCM, RRAM, RLAM, RRUM) with PC as destination register or a data section (const data in flash memory or data variable in

RAM), then the PC value is auto-incremented by 2 after the jump instruction is executed; therefore, branching to a wrong address location in code and leading to wrong program execution.

For example, a conditional jump instruction followed by data section (0140h).

@0x8012 Loop DEC.W R6

@0x8014 DEC.W R7

@0x8016 JNZ Loop

@0x8018 Value1 DW 0140h

Workaround In assembly, insert a NOP between the jump/conditional jump instruction and program code with instruction that contains PC as destination register or the data section.

DMA4 *DMA Module*

Function Corrupted write access to 20-bit DMA registers

Description When a 20-bit wide write to a DMA address register (DMAxSA or DMAxDA) is interrupted by a DMA transfer, the register contents may be unpredictable.

Workaround 1. Design the application to guarantee that no DMA access interrupts 20-bit wide accesses to the DMA address registers.

OR

2. When accessing the DMA address registers, enable the Read Modify Write disable bit (DMARMWDIS = 1) or temporarily disable all active DMA channels (DMAEN = 0).

OR

3. Use word access for accessing the DMA address registers. Note that this limits the values that can be written to the address registers to 16-bit values (lower 64K of Flash).

DMA7 *DMA Module*

Function DMA request may cause the loss of interrupts

Description If a DMA request is received during the time when the read address of a read-modify-write instruction is on the Memory Address Bus (MAB), application interrupts could be lost.

Workaround Set the DMARMWDIS bit when using the DMA.

DMA8 *DMA Module*

Function DMA can corrupt values on write-access to program stack

Description If the DMA controller makes a write access to the stack while executing one of the following instructions, the data that is written may be corrupted.

CALLA [REG | IDX | SYM | ABS | IND | INA | IMM]

PUSHX.A [IDX | SYM | ABS | IND | IMM | INA]

PUSHX.A [REG]

PUSHM.A [REG]

POPM.A [REG]

Note: [...] denotes an addressing mode

Workaround Do not declare function-scope variables. Declare all variables that are intended to be modified by the DMA as global- or file-scope such that they are allocated in the data section of RAM and not on the program stack.

EEM8 *EEM Module*

Function Debugger stops responding when using the DMA

Description In repeated transfer mode, the DMA automatically reloads the size counter (DMAxSZ) once a transfer is complete and immediately continues to execute the next transfer unless the DMA Enable bit (DMAEN) has been previously cleared. In burst-block transfer mode, DMA block transfers are interleaved with CPU activity 80/20% - of ten CPU cycles, eight are allocated to a block transfer and two are allocated for the CPU.

Because the JTAG system must wait for the CPU bus to be clear to halt the device, it can only do so when two conditions are met:

- Three clock cycles after any DMA transfer, the DMA is no longer requesting the bus.

and

- The CPU is not requesting the bus.

Therefore, if the DMA is configured to operate in the repeat burst-block transfer mode, and a breakpoint is set between the line of code that triggers the DMA transfers and the line that clears the DMAEN bit, the DMA always requests the bus and the JTAG system never gains control of the device.

Workaround When operating the DMA in repeat burst-block transfer mode, set breakpoint(s) only when the DMA transfers are not active (before the start or after the end of the DMA transfers).

EEM9 *EEM Module*

Function Combined triggers on the PUSH instruction may be missed

Description When the PUSH instruction is used in any addressing mode except register or immediate modes, a combined trigger may be missed when its conditions are defined by a PUSH instruction fetch and a successful match of the value being pushed onto stack.

Workaround None

EEM11 *EEM Module*

Function Conditional register write trigger fails while executing rotate instructions

Description A conditional register write trigger will fail to generate the expected breakpoint if the trigger condition is a result of executing one of the following rotate instructions: RRUM,RRCM, RRAM and RLAM.

Workaround None

Note: This erratum applies to debug mode only.

EEM13 *EEM Module*

Function Halting the debugger does not return correct PC value when in LPM

Description When debugging, if the device is in any low power mode and the debugger is halted, the program counter update by the debugger is corrupted. The debugger is unable to halt at the correct location.

Workaround None.

Note: This erratum applies to debug mode only.

EEM14 *EEM Module*

Function Single-step or breakpoint on module registers with WAIT capability may not work

Description In debug mode, the CPU clock is driven independently from the wait inputs of device modules (i.e., MULT, USB, RF1A, CRC). As a result, an EEM halt on an access to the module data registers (breakpoint or single-step) may show incorrect results due to incomplete execution.

Workaround Do not single-step through a data register access that holds the CPU to provide a valid result. Place breakpoints after the affected register is accessed and sufficient clock cycles have been provided.

Note: This erratum applies to debug mode only.

EEM16 *EEM Module*

Function The state storage display does not work reliably when used on instructions with CPU Wait cycles.

Description When executing instructions that require wait states; the state storage window updates incorrectly. For example a flash erase instruction causes the CPU to be held until the erase is completed i.e. the flash puts the CPU in a wait state. During this time if the state storage window is enabled it may incorrectly display any previously executed instruction multiple times.

Note: This erratum affects debug mode only.

Workaround Do not enable the state storage display when executing instructions that require wait states. Instead set a breakpoint after the instruction is completed to view the state storage display.

EEM17 *EEM Module*

Function Wrong Breakpoint halt after executing Flash Erase/Write instructions

Description Hardware breakpoints or Conditional Address triggered breakpoints on instructions that follow Flash Erase/Write instructions, stops the debugger at the actual Flash Erase/Write instruction even though the flash erase/write operation has already been executed. The hardware/conditional address triggered breakpoints that are placed on either the next two single opcode instructions OR the next double opcode instruction that follows the Flash Erase/Write instruction are affected by this erratum.

Note: This erratum affects debug mode only.

Workaround None. Use other conditional/advanced triggered breakpoints to halt the debugger right after Flash erase/write instructions.

FLASH29 *FLASH Module*

Function Read disturb due to emergency exit from write/erase Flash operation

Description When a Flash write or erase is abruptly terminated, any further reliable reads from Flash are not guaranteed. The abrupt termination can occur as a result of the Emergency Exit bit (EMEX in FCTL3) being set. This forces a write or an erase operation to be terminated before normal completion.

Workaround After setting EMEX = 1, wait for at least 100 us after a bank or mass erase and at least 6 us after a segment erase before Flash is accessed again.

FLASH31 *FLASH Module*

Function Interrupts not disabled during FLASH erase operation

Description When a flash erase operation is in progress, interrupts are not automatically disabled.

The CPU will always try to service the interrupt request, whether or not the flash is busy.

Workaround Disable interrupts using the GIE bit before erasing flash in another bank of memory. Note that all interrupts during this period of time will remain pending until GIE = 1.

FLASH37 *FLASH Module*

Function Corrupted flash read when SVM low-side flag is triggered

Description If the SVM low side is enabled, a change in the VCORE voltage level (an increase in the VCORE level) may cause the currently executed read operation from flash to be incorrect and may lead to unexpected code execution or incorrect data. This can happen under any one of the following conditions:

- When the VCORE is changed in application, the SVM low side is used to indicate if the core voltage has settled by using the SVMDLYIFG flag. The failure occurs only when a flash access is concurrent to the expiration of the settling time delay.

- Unexpected changes in the VCORE voltage level

For code examples and detailed guidance on the PMM operation and software APIs for PMM configuration see the driverlib APIs from 430Ware (MSP430Ware).

Workaround - Execute the procedure to change the VCORE level from RAM.

or

- If executing from flash, follow the procedure below when increasing the VCORE level. Note: To apply this workaround, the SVM low-side comparator must operate in normal mode (SVMLFP = 0 in SVMLCTL).

```
// Set SVM highside to new level and check if a VCore increase is possible
SVSMHCTL = SVMHE | SVSHE | (SVSMHRRL0 * level);
// Wait until SVM highside is settled
while ((PMMIFG & SVSMHDLYIFG) == 0);
// Clear flag
PMMIFG &= ~SVSMHDLYIFG;
// Set also SVS highside to new level
// Vcc is high enough for a Vcore increase
SVSMHCTL |= (SVSHRVL0 * level);
// Wait until SVM highside is settled
while ((PMMIFG & SVSMHDLYIFG) == 0);
// Clear flag
PMMIFG &= ~SVSMHDLYIFG;

//**************flow change for errata workaround ************
// Set VCore to new level
PMMCTL0_L = PMMCOREV0 * level;

// Set SVM, SVS low side to new level
SVSMLCTL = SVMLE | (SVSMLRRL0 * level)| SVSLE | (SVSLRVL0 * level);
// Wait until SVM, SVS low side is settled
```

```
while ((PMMIFG & SVSMLDLYIFG) == 0);
// Clear flag
PMMIFG &= ~SVSMLDLYIFG;
//**************flow change for errata workaround ************
```

JTAG20 *JTAG Module*

Function BSL does not exit to application code

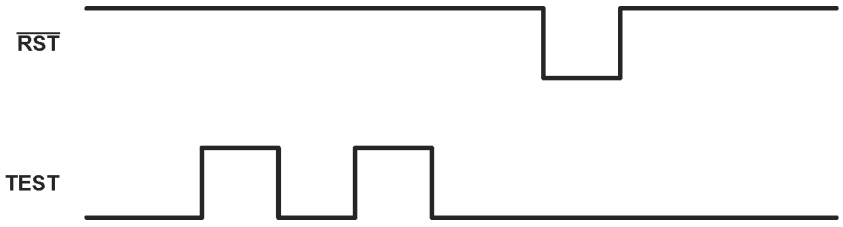
Description The methods used to exit the BSL per MSP430 Programming Via the Bootstrap Loader (SLAU319) are invalid.

Workaround To exit the BSL one of the following methods must be used.

- A Power cycle

or

- Toggle the TEST pin twice when nRST is high and then pull nRST low.



Note: This sequence is not subject to timing constraints and the appropriate level transitions are sufficient to trigger an exit from BSL mode.

MPY1 *MPY Module*

Function Save and Restore feature on MPY32 not functional

Description The MPY32 module uses the Save and Restore method which involves saving the multiplier state by pushing the MPY configuration/operand values to the stack before using the multiplier inside an Interrupt Service Routine (ISR and then restoring the state by popping the configuration/operand values back to the MPY registers at the end of the ISR. However due to the erratum the Save and Restore operation fails causing the write operation to the OP2H register right after the restore operation to be ignored as it is not preceded by a write to OP2L register resulting in an invalid multiply operation.

Workaround None. Disable interrupts when writing to OP2L and OP2H registers.

Note: When using the C-compiler, the interrupts are automatically disabled while using the MPY32

PMAP1 *PMAP Module*

Function Port Mapping Controller does not clear unselected inputs to mapped module.

Description The Port Mapping Controller provides the logical OR of all port mapped inputs to a module (Timer, USCI, etc). If the PSEL bit (PxSEL.y) of a port mapped input is cleared, then the logic level of that port mapped input is latched to the current logic level of the input. If the input is in a logical high state, then this high state is latched into the input of

the logical OR. In this case, the input to the module is always a logical 1 regardless of the state of the selected input.

Workaround

1. Drive input to the low state before clearing the PSEL bit of that input and switching to another input source.

or

2. Use the Port Mapping Controller reconfiguration feature, PMAPRECFG, to select inputs to a module and map only one input at a time.

PMM8 *PMM Module*

Function

Supply current in LPM4.5 is unpredictable

Description

Due to an unpredictable value of the supply current in LPM4.5, the mode should not be used.

Workaround

None.

PMM9 *PMM Module*

Function

False SVSxIFG events

Description

The comparators of the SVS require a certain amount of time to stabilize and output a correct result once re-enabled; this time is different for the Full Performance versus the Normal mode. The time to stabilize the SVS comparators is intended to be accounted for by a built-in event-masking delay of 2 us when Full Performance mode is enabled.

However, the comparators of the SVS in Full Performance mode take longer than 2 us to stabilize so the possibility exists that a false positive will be triggered on the SVSH or SVSL. This results in the SVSxIFG flags being set and depending on the configuration of SVSxPE bit a POR can also be triggered.

Additionally when the SVSxIFGs are set, all GPIOs are tri-stated i.e. floating until the SVSx comparators are settled.

The SVS IFG's are falsely set under the following conditions:

1. Wakeup from LPM2/3/4 when SVSxMD = 0 (default setting) && SVSxFP=1. The SVSx comparators are disabled automatically in LPM2/3/4 and are then re-enabled on return to active mode.

2. SVSx is turned on in full performance mode (SVSxFP=1).

3. A PUC/POR occurs after SVSx is disabled. After a PUC or POR the SVSx are enabled automatically but the settling delay does not get triggered. Based on SVSxPE bit this may lead to POR events until the SVS comparator is fully settled.

Workaround

For each of the above listed conditions the following workarounds apply:

1. If the Full Performance mode is to be enabled for either the high- or low-side SVS comparators, the respective SVSxMD bits must be set (SVSxMD = 1) such that the SVS comparators are not temporarily shut off in LPM2/3/4. Note that this is equivalent to a 2 uA (typical) adder to the low power mode current, per the device-specific datasheet, for each SVSx that remains enabled.

2. The SVSx must be turned on in normal mode (SVSxFP=0). It can be reconfigured to use full performance mode once the SVSx/SVMx delay has expired.

3. Ensure that SVSH and SVSL are always enabled.

PMM10 *PMM Module*

Function SVS/SVM flags disabled after Power Up Clear reset

Description SVS/SVM interrupt flag functionality is disabled after a Power Up Clear (PUC) Reset if the SVS was disabled before the PUC reset was applied.

Workaround A write access to the intended SVSx register after PUC re-enables the SVS & SVM interrupt flags.

PMM11 *PMM Module*

Function MCLK comes up fast on exit from LPM3 and LPM4

Description The DCO exceeds the programmed frequency of operation on exit from LPM3 and LPM4 for up to 6 us. This behavior is masked from affecting code execution by default: SVSL and SVML run in normal-performance mode and mask CPU execution for 150 us on wakeup from LPM3 and LPM4. However, when the low-side SVS and the SVM are disabled or are operating in full-performance mode (SVMLE = 0 and SVSLE = 0, or SVMLFP = 1 and SVSLFP = 1) AND MCLK is sourced from the internal DCO running over 4 MHz, 7 MHz, 11 MHz, or 14 MHz at core voltage levels 0, 1, 2, and 3, respectively, the mask lasts only 2 us. MCLK is, therefore, susceptible to run out of spec for 4 us.

Workaround Set the MCLK divide bits in the Unified Clock System Control 5 Register (UCSCTL5) to divide MCLK by two prior to entering LPM3 or LPM4 (set DIVMx = 001). This prevents MCLK from running out of spec when the CPU wakes from the low-power mode. Following the wakeup from the low-power mode, wait 32, 48, 80, or 100 cycles for core voltage levels 0, 1, 2, and 3, respectively, before resetting DIVMx to zero and running MCLK at full speed [for example, __delay_cycles(100)].

PMM12 *PMM Module*

Function SMCLK comes up fast on exit from LPM3 and LPM4

Description The DCO exceeds the programmed frequency of operation on exit from LPM3 and LPM4 for up to 6 us. When SMCLK is sourced by the DCO, it is not masked on exit from LPM3 or LPM4. Therefore, SMCLK exceeds the programmed frequency of operation on exit from LPM3 and LPM4 for up to 6 us. The increased frequency has the potential to change the expected timing behavior of peripherals that select SMCLK as the clock source.

Workaround - Use XT2 as the SMCLK oscillator source instead of the DCO.

or

- Do not disable the clock request bit for SMCLKREQEN in the Unified Clock System Control 8 Register (UCSCTL8). This means that all modules that depend on SMCLK to operate successfully should be halted or disabled before entering LPM3 or LPM4. If the increased frequency prevents the proper function of an affected module, wait 32, 48, 80, or 100 cycles for core voltage levels 0, 1, 2, or 3, respectively, before re-enabling the module [for example, __delay_cycles(100)].

PMM14 *PMM Module*

Function Increasing the core level when SVS/SVM low side is configured in full-performance

mode causes device reset

Description When the SVS/SVM low side is configured in full performance mode (SVSMLCTL.SVSLFP = 1), the setting time delay for the SVS comparators is ~2us. When increasing the core level in full-performance mode; the core voltage does not settle to the new level before the settling time delay of the SVS/SVM comparator expires. This results in a device reset.

Workaround When increasing the core level; enable the SVS/SVM low side in normal mode (SVSMLCTL.SVSLFP=0). This provides a settling time delay of approximately 150us allowing the core sufficient time to increase to the expected voltage before the delay expires.

PMM15 *PMM Module*

Function Device may not wake up from LPM2, LPM3, or LPM4

Description Device may not wake up from LPM2, LPM3 or LMP4 if an interrupt occurs within 1 us after the entry to the specified LPMx; entry can be caused either by user code or automatically (for example, after a previous ISR is completed). Device can be recovered with an external reset or a power cycle. Additionally, a PUC can also be used to reset the failing condition and bring the device back to normal operation (for example, a PUC caused by the WDT).

This effect is seen when:

- A write to the SVSMHCTL and SVSMLCTL registers is immediately followed by an LPM2, LPM3, LPM4 entry without waiting the requisite settling time ((PMMIFG.SVSMLDLYIFG = 0 and PMMIFG.SVSMHDLYIFG = 0)).

or

The following two conditions are met:

- The SVSL module is configured for a fast wake-up or when the SVSL/SVML module is turned off. The affected SVSMLCTL register settings are shaded in the following table.

	SVSLE	SVSLMD	SVSLFP	AM, LPM0/1 SVSL state	Manual SVSMLACE = 0 LPM2/3/4 SVSL State	Automatic SVSMLACE = 1 LPM2/3/4 SVSL State	Wakeup Time LPM2/3/4
SVSL	0	x	x	OFF	OFF	OFF	$t_{WAKE-UP\ FAST}$
	1	0	0	Normal	OFF	OFF	$t_{WAKE-UP\ SLOW}$
	1	0	1	Full Performance	OFF	OFF	$t_{WAKE-UP\ FAST}$
	1	1	0	Normal	Normal	OFF	$t_{WAKE-UP\ SLOW}$
	1	1	1	Full Performance	Full Performance	Normal	$t_{WAKE-UP\ FAST}$
	SVMLE	SVMLFP		AM, LPM0/1 SVML state	Manual SVSMLACE = 0 LPM2/3/4 SVML State	Automatic SVSMLACE = 1 LPM2/3/4 SVML State	Wakeup Time LPM2/3/4
SVML	0	x		OFF	OFF	OFF	$t_{WAKE-UP\ FAST}$
	1	0		Normal	Normal	OFF	$t_{WAKE-UP\ SLOW}$
	1	1		Full Performance	Full Performance	Normal	$t_{WAKE-UP\ FAST}$

and

-The SVSH/SVMH module is configured to transition from Normal mode to an OFF state when moving from Active/LPM0/LPM1 into LPM2/LPM3/LPM4 modes. The affected SVSMHCTL register settings are shaded in the following table.

	SVSHE	SVSHMD	SVSHFP	AM, LPM0/1 SVSH state	Manual SVSMHACE = 0 LPM2/3/4 SVSH State	Manual SVSMHACE = 1 LPM2/3/4 SVSH State
SVSH	0	x	x	OFF	OFF	OFF
	1	0	0	Normal	OFF	OFF
	1	0	1	Full Performance	OFF	OFF
	1	1	0	Normal	Normal	OFF
	1	1	1	Full Performance	Full Performance	Normal
SVMH	SVSHE	SVMHFP		AM, LPM0/1 SVSH state	Manual SVSMHACE = 0 LPM2/3/4 SVSH State	Manual SVSMHACE = 1 LPM2/3/4 SVSH State
	0	x		OFF	OFF	OFF
	1	0		Normal	Normal	OFF
	1	1		Full Performance	Full Performance	Normal

Workaround

Any write to the SVSMxCTL register must be followed by a settling delay (PMMIFG.SVSMLDLYIFG = 0 and PMMIFG.SVSMHDLYIFG = 0) before entering LPM2, LPM3, LPM4.

and

1. Ensure the SVSx, SVMx are configured to prevent the issue from occurring by the following:

- Configure the SVSL module for slow wake up (SVSLFP = 0). Note that this will increase the wakeup time from LPM2/3/4 to twakeupslow (~150 us).

or

- Do not configure the SVSH/SVMH such that the modules transition from Normal mode to an OFF state on LPM entry. Instead force the modules to remain ON even in LPMx. Note that this will cause increased power consumption when in LPMx.

Refer to the MSP430F5xx and MSP430F6xx Core Libraries (SLAA448) for proper PMM configuration functions.

Use the following function, PMM15Check (void), to determine whether or not the existing PMM configuration is affected by the erratum. The return value of the function is 1 if the configuration is affected, and 0 if the configuration is not affected.

```
unsigned char PMM15Check (void)
{
// First check if SVSL/SVML is configured for fast wake-up
if ( (!(SVSMLCTL & SVSLE)) || ((SVSMLCTL & SVSLE) && (SVSMLCTL & SVSLFP)) ||
(!(SVSMLCTL & SVMLE)) || ((SVSMLCTL & SVMLE) && (SVSMLCTL & SVMLFP)) )
{ // Next Check SVSH/SVMH settings to see if settings are affected by PMM15
if ((SVSMHCTL & SVSHE) && (!(SVSMHCTL & SVSHFP)))
{
if ( (!(SVSMHCTL & SVSHMD)) || ((SVSMHCTL & SVSHMD) &&
(SVSMHCTL & SVSMHACE)) )
return 1; // SVSH affected configurations
}
if ((SVSMHCTL & SVMHE) && (!(SVSMHCTL & SVMHFP)) && (SVSMHCTL &
SVSMHACE))
```

return 1; // SVMH affected configurations

}

return 0; // SVS/M settings not affected by PMM15

}

}

2. If fast servicing of interrupts is required, add a 150us delay either in the interrupt service routine or before entry into LPM3/LPM4.

PMM17 *PMM Module*

Function Vcore exceed maximum limit of 2.0V.

Description If the device is switching between active mode and LPM2/3/4 with very high frequency, the core voltage of the device, VCORE, may rise incrementally until it is beyond 2.0 V, which is the maximum allowable limit for digital circuitry internal to the MSP430. This increase may remain undetected in an application with no functional impact but could potentially result in decreased endurance and increased wear over the lifetime of the device, because the digital circuitry is continually subjected to overvoltage.

The accumulation of Vcore affects only older lot trace codes of mentioned revisions.

Workaround The VCORE accumulation is fixed by enabling the prolongation mechanism in software. The following lines of code need to be implemented before periodic execution of LPM-to-AM-LPM. It is recommended to execute the code at program start:

ASM code:

mov.w #0x9602, &0110h;

bis.w #0x0800, &0112h;

C code:

(unsigned int)(0x0110)=0x9602;

(unsigned int)(0x0112)|=0x0800;

The automatic prolongation mechanism is disabled with a BOR and must be enabled after each boot code execution.

For detailed background information, affected LTCs and possible workaround(s) see Vcore Accumulation documentation in SLAA505.

PORT15 *PORT Module*

Function In-system debugging causes the PMALOCKED bit to be always set

Description The port mapping controller registers cannot be modified when single-stepping or halting at break points between a valid password write to the PMAPWD register and the expected lock of the port mapping (PMAP) registers. This causes the PMAPLOCKED bit to remain set and not clear as expected.

Note: This erratum only applies to in-system debugging and is not applicable when operating in free-running mode.

Workaround Do not single step through or place break points in the port mapping configuration section of code.

PORT16 *PORT Module*

Function GPIO pins are driven low during device start-up

Description During device start-up, all of the GPIO pins are expected to be in the floating input state. Due to this erratum, some of the GPIO pins are driven low for the duration of boot code execution during device start-up, if an external reset event (via the RST pin) interrupted the previous boot code execution. Boot code is always executed after a BOR, and the duration of this boot code execution is approximately 500us.

For a given device family, this erratum affects only the GPIO pins that are not available in the smallest package device family member, but that are present on its larger package variants.

Note: This erratum does not affect the smallest package device variants in a particular device family.

Workaround Ensure that no external reset is applied via the RST pin during boot code execution of the device, which occurs 1us after device start-up.

Note: System application needs to account for this erratum in to ensure there is no increased current draw by the external components or damage to the external components in the system during device start-up

RF1A1 *RF1A Module*

Function The PLL lock detector output is not 100% reliable

Description The PLL lock detector output is not 100% reliable and might toggle even if the PLL is in lock. The PLL is in lock if the lock detector output has a positive transition or is constantly logic high. The PLL is not in lock if the lock detector output is constantly logic low. It is not recommended to check for PLL lock by reading PKTSTATUS[0] with GDOx_CFG=0x0A or PKTSTATUS[2] register with GDOx_CFG=0x0A (x = 0 or 2).

Workaround PLL lock can be checked reliably by these methods:

- Program register IOCFGx.GDOx_CFG=0x0A and use the lock detector output available on the GDOx pin as an interrupt for the MCU. A positive transition on the GDOx pin means that the PLL is in lock. It is important to disable for interrupt when waking the chip from SLEEP state as the wake-up might cause the GDOx pin to toggle when it is programmed to output the lock detector.

or

- Read register FSCAL1. The PLL is in lock if the register content is different from 0x3F.

With both of the above workarounds the CC1101 PLL calibration should be carried out with the correct settings for TEST0.VCO_SEL_CAL_EN and FSCAL2.VCO_CORE_H_EN. These settings are depending on the operating frequency, and is calculated automatically by SmartRF Studio.

Note that the TEST0 register content is not retained in SLEEP state, and thus it is necessary to write to this register as described

above when returning from the SLEEP state.

RF1A2 *RF1A Module*

Function RXFIFO overflow flag does not work as intended

Description In addition to having a 64-byte long RX FIFO, the CC430 has a one byte long pre-fetch buffer between the FIFO and the RF1A module. It also has buffers for status registers

and CRC bytes. If more than 65 bytes have been received (the FIFO and the pre-fetch buffer are full) without reading the RX FIFO, the radio will enter RXFIFO_OVERFLOW state. There are, however, some cases where the radio will be stuck in RX state instead of entering RXFIFO_OVERFLOW state. Below is a table showing the register settings that will cause this problem. APPEND_STATUS is found in the PKTCTRL1 register, and CRC_EN is found in the PKTCTRL0 register.

Setting IOCFGx=0x06 should mean that the GDO signal is deasserted when the RXFIFO overflows. In the cases where the radio is stuck in RX state, the GDOx pin will not be deasserted.

When the radio is stuck in this RX state it draws current as if it was in the RX state, but it will not be able to receive any more data. The only way to get out of this state is to issue an SIDLE strobe and then flush the FIFO (SFRX).

Workaround In applications where the packets are short enough to fit in the RX FIFO and one wants to wait for the whole packet to be received before starting to read the RX FIFO, for variable packet length mode (PKTCTRL0.LENGTH_CONFIG=1) the PKTLEN register should be set to 61 to make sure the whole packet including status bytes are 64 bytes or less (length byte (61) + 61 payload bytes + 2 status bytes = 64 bytes) or PKTLEN = 62 if fixed packet length mode is used (PKTCTRL0.LENGTH_CONFIG=0). In application where the packets do not fit in the RX FIFO, one must start reading the RX FIFO before it reaches its limit (64 bytes).

RF1A3 *RF1A Module*

Function Extra Byte Transmitted in TX

Description If a transmission is aborted (exits TX mode) during the transmission of the first half of any byte, there will be a repetition of the first byte in the next transmission. This issue is caused by a state machine controlling the mod_rd_data signal in the modulator. This signal asserts at the start of transmission of each full byte, then deasserts after half the byte has been transmitted. If the transmission is aborted after a byte has started but before half the byte is transmitted this signal remains asserted and the first byte in the next transmission is repeated.

Workaround As long as the packet handling features of the CC430 are used, this is not a problem since the chip always exits TX mode after the transmission of the last bit in the last byte of the packet. If, however, one disables the packet handling features (MDMCFG2.SYNC_MODE=0) and wants to exit TX mode manually by strobing IDLE, one should make sure that the IDLE strobe is being issued after clocking out 12 dummy bits (8 dummy bits are necessary due to the TX latency, but since this would mean that transmission is aborted within the first half of a byte, 4 extra bits are added).

RF1A5 *RF1A Module*

Function FIFO Radio Core Interrupt may be triggered independent of the RFINx condition being met

Description The radio core interrupt flags (RFIFGx) may be set and could generate a radio core interrupt although the corresponding radio input (RFINx) signal condition has not been met.

This is true for the FIFO Mapped Control Signals RFIFG3, RFIFG4, RFIFG5, RFIFG6, RFIFG7, RFIFG8, RFIFG9 (negative edge), and RFIFG10 (negative edge).

Workaround When handling the radio core interrupts RFIFG3 - RFIFG10, proceed with the ISR only after verifying that the RFINx signal respective to the RFIFGx flag is active.

RF1A6 *RF1A Module*

Function LVERR flag set when radio in SLEEP or IDLE and VCORE = 0, 1

Description The low-voltage error flag (LVERR) is set when the radio is in the SLEEP or IDLE state and VCORE = 0 or 1, which is contrary to the behavior specified in the CC430 User's Guide.

Workaround None.

RF1A8 *RF1A Module*

Function RF1AIN10 bit does not reset after the first byte of the RX FIFO is read

Description The intended behavior of RF1AIN10 bit is that it is set after the last byte is received [into RX FIFO] and reset after the first byte is read from the RX FIFO. However, the RF1AIN10 bit does not reset after the first byte of the RX FIFO is read.

Workaround Use RF1AIN9 for RX handling instead. To verify the RX packet CRC, enable the RF1A option to append the CRC_OK bit to the end of the RX packet. The CRC_OK bit can be checked after reading out the RX FIFO buffer.

SYS16 *SYS Module*

Function Fast Vcc ramp after device power up may cause a reset

Description At initial power-up, after Vcc crosses the bownout threshold and reaches a constant level, an abrupt ramp of Vcc at a rate dV/dT > 1V/100us can cause a brownout condition to be incorrectly detected even though Vcc does not fall below the brownout threshold. This causes the device to undergo a reset.

Workaround Use a controlled Vcc ramp to power up the device.

TAB23 *TIMER_A/TIMER_B Module*

Function TAxR/TBxR read can be corrupted when TAxR/TBxR = TAxCCR0/TBxCCR0

Description When a timer in Up mode is stopped and the counter register (TAxR/TBxR) is equal to the TAxCCR0/TBxCCR0 value, a read of the TAR/TBR register may return an unexpected result.

Workaround 1. Use 'Up/Down' mode instead of 'Up' mode

OR

2. In 'Up' mode, use the timer interrupt instead of halting the counter and reading out the value in TAxR/TBxR

OR

3. When halting the timer counter in 'Up' mode, reinitialize the timer before starting to run again.

UCS6 *UCS Module*

Function USCI source clock does not turn off in LPM3/4 when UART is idle

Description The USCI clock source (ACLK/SMCLK) remains enabled in LPM3 and LPM4 when the

USCI is configured in UART mode and the communication is idle (UCSWRST = 0 but no TX or RX currently executing). This is contrary to the expected automatic clock activation described in the User's Guide and can lead to higher current consumption in low power modes, depending on the oscillator that feeds ACLK / SMCLK.

Workaround Use the oscillator that is already active in LPM3 (ACLK) to source the USCI and utilize the low-power baud rate generator (UCOS16 = 0). For UART baud rates where a fast SMCLK sourced by the internal DCO is required use LPM0 instead of LPM3.

UCS7 *UCS Module*

Function DCO drifts when servicing short ISRs when in LPM0 or exiting active from ISRs for short periods of time

Description The FLL uses two rising edges of the reference clock to compare against the DCO frequency and decide on the required modifications to the DCOx and MODx bits. If the device is in a low power mode with FLL disabled (LPM0 with DCO not sourcing ACLK/SMCLK or LPM2, LPM3, LPM4 where SCG1 bit is set) and enters a state which enables FLL (enter ISR from LPM0/LPM2 or exit active from ISRs) for a period less than 3x reference clock cycles, then the FLL will cause the DCO to drift.

This occurs because the FLL immediately begins comparing an active DCO with its reference clock and making the respective modifications to the DCOx and MODx bits. If the FLL is not given sufficient time to capture a full reference clock cycle (2 x reference clock periods) and adjust accordingly (1 x reference clock period), then the DCO will keep drifting each time the FLL is enabled.

Workaround (1) If DCO is not sourcing ACLK or SMCLK in the application, use LPM1 instead of LPM0 to make sure FLL is disabled when interrupt service routine is serviced.

(2) When exiting active from ISRs, insert a delay of at least 3 x reference clock periods. To save on power budget, the 3 x reference clock periods could also be spent in LPM0 with TimerA or TimerB using ACLK/SMCLK sourced from DCO. This way, the FLL and DCO are still active in LPM0.

UCS9 *UCS Module*

Function Digital Bypass mode prevents entry into LPM4

Description When entering LPM4, if an external digital input applied to XT1 in HF mode or XT2 is not turned off, the PMM does not switch to low-current mode causing higher than expected power consumption.

Workaround Before entering LPM4:

(1) Switch to a clock source other than external bypass digital input.

OR

(2) Turn off external bypass mode (UCSCTL6.XT1BYPASS = 0).

UCS10 *UCS Module*

Function Modulation causes shift in DCO frequency

Description When the FLL is enabled, the DCO frequency can be tracked automatically by modifying the DCOx and MODx bits. The MODx bits switch between the frequency selected by the DCO bits and the next-higher frequency set by (DCO + 1). The erroneous behavior is seen when the FLL is tracking close to a DCO step boundary and the MOD counter is

expected to rollover, but instead the DCO bits increment and the MOD bits decrement. This causes the DCO to shift by up to 12% and remain at an increased frequency until approximately 15 REFCLK cycles have elapsed. The frequency reverts to the expected value immediately afterward.

For example, the modulator moves from DCOx = n and MODx = 31 to DCOx = n + 1

and MODx = 30, causing a large increase in the DCO frequency.

Applications could be impacted as follows:

When using the DCO frequency for asynchronous serial communication and timer operation, the effect can be seen as corrupted data or incorrect timing events.

Workaround

(1) Turn off the FLL.

Or

(2) Implement a Software FLL, comparing the DCO frequency to a known reference such as REFO or LFXT1 using a timer capture and tuning the value of the DCO and MOD bits periodically.

Or

(3) Execute the following sequence in periodic intervals.

1. Disable peripherals sourced by the DCO such as UART and Timer.

2. Turn on the FLL.

3. Wait the worst case settling time of 32 X 32 X fFLLREFCLK to allow it to lock to the target frequency.

4. Turn off the FLL.

5. Compare the DCO frequency to a known reference such as REFO or LFXT1 using a timer capture.

- If the DCO frequency is higher than expected, repeat from step (2) until the

frequency reaches to the expected range.

- Else proceed with code execution.

See the application report UCS10 Guidance SLAA489 for more detailed information regarding working with this erratum. This erratum does not affect proper operation of the CPU when MCLK = DCO/FLL and is set to the maximum clock frequency specified in the device datasheet.

UCS11 *UCS Module*

Function

Modifying UCSCTL4 clock control register triggers an erroneous clock source request

Description

Changing the SELM/SELS/SELA bits in the UCSCTL4 register might trigger the respective clocks to select an incorrect clock source which requests the XT1/XT2 clock. If the crystals are not present at XT1/XT2 or present but not yet configured in the application firmware, then the respective XT1/XT2 fault flag is falsely set.

Workaround

Clear all the fault flags in UCSCTL7 register once after changing any of the SELM/SELS/SELA bits in the UCSCTL4 register.

USCI26 *USCI Module*

Function

Tbuf parameter violation in I2C multi-master mode

Description

In multi-master I2C systems the timing parameter Tbuf (bus free time between a stop condition and the following start) is not guaranteed to match the I2C specification of 4.7us in standard mode and 1.3us in fast mode. If the UCTXSTT bit is set during a running I2C transaction, the USCI module waits and issues the start condition on bus release causing the violation to occur.

Note: It is recommended to check if UCBBUSY bit is cleared before setting UCTXSTT=1.

Workaround

None

USCI30 *USCI Module*

Function

I2C mode master receiver / slave receiver

Description

When the USCI I2C module is configured as a receiver (master or slave), it performs a double-buffered receive operation. In a transaction of two bytes, once the first byte is moved from the receive shift register to the receive buffer the byte is acknowledged and the state machine allows the reception of the next byte.

If the receive buffer has not been cleared of its contents by reading the UCBxRXBUF register while the 7th bit of the following data byte is being received, an error condition may occur on the I2C bus. Depending on the USCI configuration the following may occur:

1) If the USCI is configured as an I2C master receiver, an unintentional repeated start condition can be triggered or the master switches into an idle state (I2C communication aborted). The reception of the current data byte is not successful in this case.

2) If the USCI is configured as I2C slave receiver, the slave can switch to an idle state stalling I2C communication. The reception of the current data byte is not successful in this case. The USCI I2C state machine will notify the master of the aborted reception with a NACK.

Note that the error condition described above occurs only within a limited window of the 7th bit of the current byte being received. If the receive buffer is read outside of this window (before or after), then the error condition will not occur.

Workaround

a) The error condition can be avoided altogether by servicing the UCBxRXIFG in a timely manner. This can be done by (a) servicing the interrupt and ensuring UCBxRXBUF is read promptly or (b) Using the DMA to automatically read bytes from receive buffer upon UCBxRXIFG being set.

OR

b) In case the receive buffer cannot be read out in time, test the I2C clock line before the UCBxRXBUF is read out to ensure that the critical window has elapsed. This is done by checking if the clock line low status indicator bit UCSCLLOW is set for atleast three USCI bit clock cycles i.e. 3 X t(BitClock).

Note that the last byte of the transaction must be read directly from UCBxRXBUF. For all other bytes follow the workaround:

Code flow for workaround

(1) Enter RX ISR for reading receiving bytes

(2) Check if UCSCLLOW.UCBxSTAT == 1

(3) If no, repeat step 2 until set

(4) If yes, repeat step 2 for a time period > 3 x t (BitClock) where t (BitClock) = 1/ f (BitClock)

(5) If window of 3 x t(BitClock) cycles has elapsed, it is safe to read UCBxRXBUF

USCI31 — *USCI Module*

Function Framing Error after USCI SW Reset (UCSWRST)

Description While receiving a byte over USCI-UART (with UCBUSY bit set), if the application resets the USCI module (software reset via UCSWRST), then a framing error is reported for the next receiving byte.

Workaround 1. If possible, do not reset USCI-UART during an ongoing receive operation; that is, when UCBUSY bit is set.

2. If the application software resets the USCI module (via the UCSWRST bit) during an ongoing receive operation, then set and reset the UCSYNC bit before releasing the software USCI reset.

Workaround code sequence:

```
bis #UCSWRST, &UCAxCTL1 ; USCI SW reset
;Workaround begins
bis #UCSYNC, &UCAxCTL0 ; set synchronous mode
bic #UCSYNC, &UCAxCTL0 ; reset synchronous mode
;Workaround ends
bic #UCSWRST, &UCAxCTL1 ; release USCI reset
```

WDG4 — *WDT Module*

Function The WDT failsafe can be disabled

Description The UCS is capable of masking clock requests (ACLK, SMCLK, MCLK) from peripheral modules; see request enable (REQEN) bits in the UCS control register, UCSCTL8.

The clock request logic of the UCS is used by the WDT module to ensure a fail-safe clock source in all low-power modes. Therefore, de-asserting the request enable bit of the watchdog clock source (xCLKREQEN = 0) allows the respective clock to be disabled upon entry into a low-power mode. Without an active clock source, the WDT timer stops incrementing and a watchdog event will not occur.

Workaround None

4 Document Revision History

Changes from family erratasheet to device specific erratasheet.

1. Errata JTAG21 was removed
2. Errata RTC4 was removed
3. Errata PORT16 was added
4. Errata UCS11 was added
5. Errata USCI31 was added
6. RGZ48 package markings have been updated

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